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## APPLICATION NOTE

# Control of a Brushless DC Motor (H8/3664)

### Introduction

The H8/3664 is used to control a brushless DC motor in the way shown in Figure 1.1.

### Target Device

H8/300H Tiny Series H8/3664

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## 1. Specifications

1. The H8/3664 is used to control a brushless DC motor in the way shown in Figure 1.1.
2. The H8/3664 detects signals that indicate the positions of the rotor's magnetic poles and operates the motor by producing six PWM waveforms that provide control of the rotating magnetic field according to the positional signals from the motor.
3. The H8/3664's built-in timer generates a PWM waveform that handles chopping control for the motor.

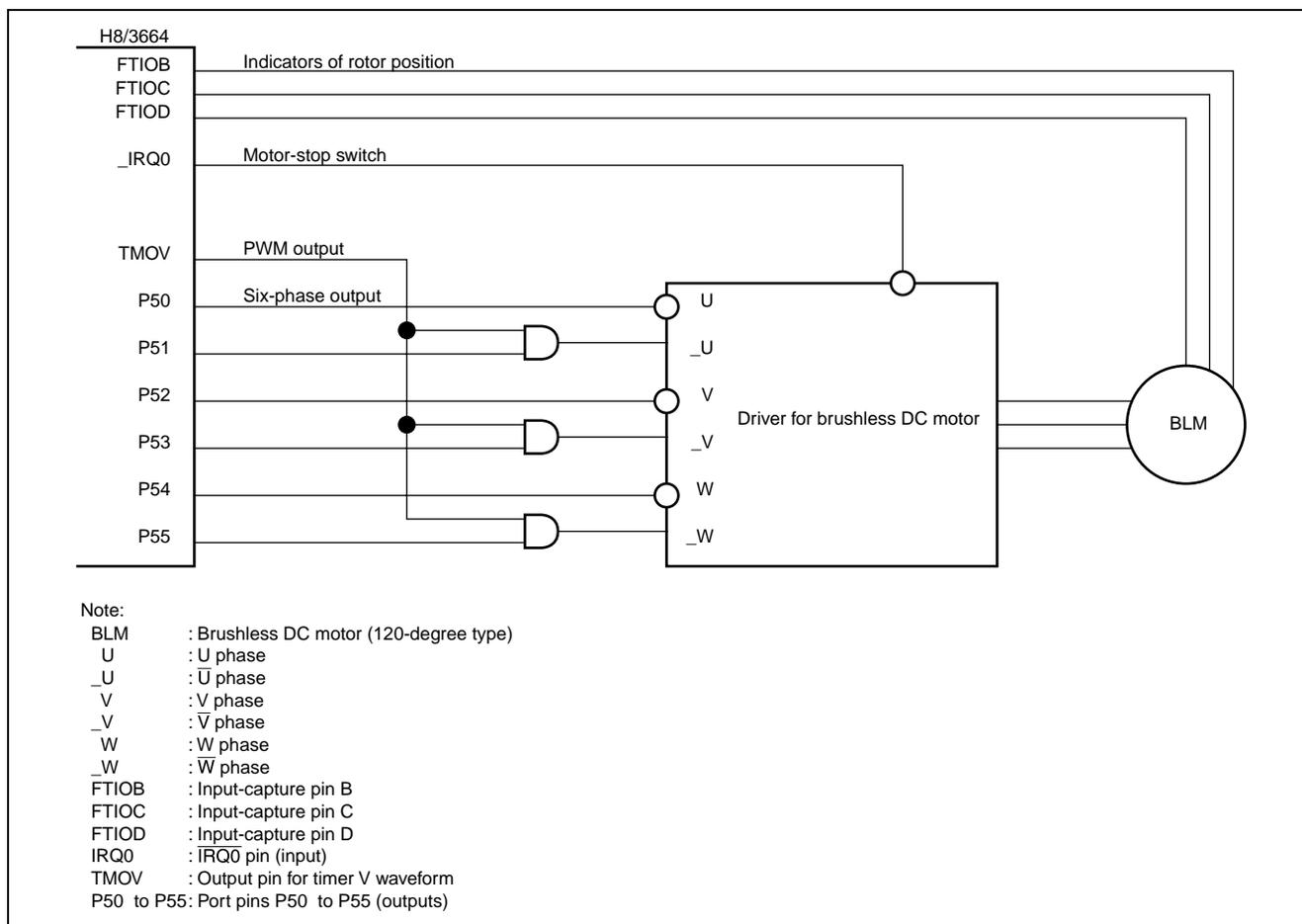


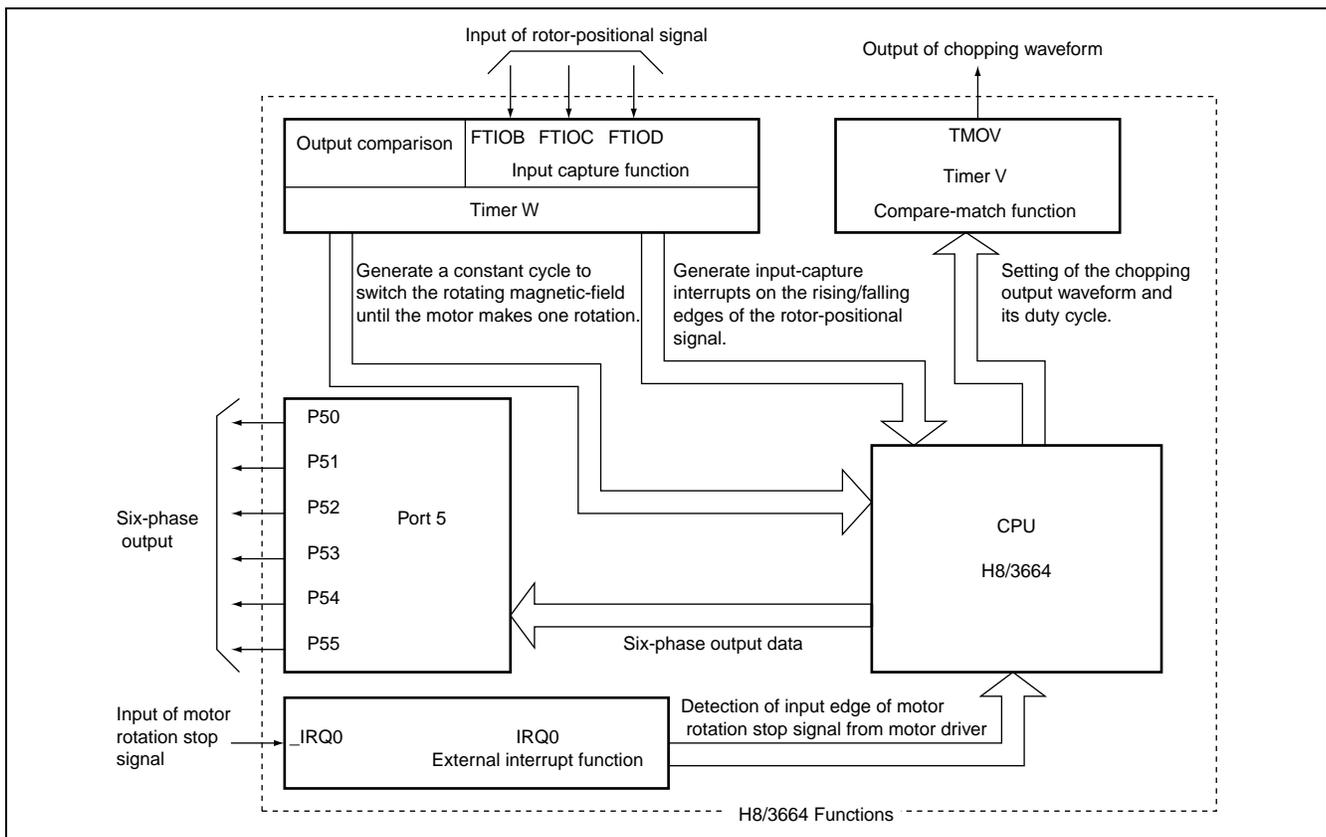
Figure 1.1 Set-up for Controlling a Brushless DC Motor

## 2. Design

1. The PWM waveforms for the motor are generated by the timer and output through I/O-port pins.
2. In the initial stage of the motor's operation, the motor is started by sequential switching of the excited phase on a constant cycle.
3. After switching the excited phase six times, control by the CPU shifts to the procedure where control of the motor is based on the rotor-positional signals from the motor.
4. The positional signals from the motor are taken in through the input-capture terminals of timer W and drive the generation of interrupts.
5. These interrupts drive switching to produce a rotating magnetic field and control phase excitation through chopping.

## 3. Description of Functions Used

1. As shown in Figure 3.1, timers W (input capture/output comparison) and V (compare-match), an I/O port (Port 5) and the IRQ (external interrupt) of the H8/3664 are used to implement the functions required to control a brushless DC motor.



**Figure 3.1 Block Diagram of the Configuration for Controlling a Brushless DC Motor**

The tasks performed by the H8/3664 functional blocks are outlined below.

- Timer W input capture: generates an interrupt request for the CPU on the rising and falling edges of the rotor-positional signal.
- Timer W output comparison: generates an interrupt request for the CPU at the end of each magnetic-field rotation switching cycle (period that corresponds to 60 degrees at the motor's frequency of rotation) until the motor has made one rotation.
- Timer V compare-match function: generates the waveform for chopping control when the driver transistor turns on; this is output through the TMOV pin.
- Port 5 function: outputs six-phase data to the motor driver.
- IRQ external interrupt function: stops the motor in response to the external rotation-stop signal.

2. Detailed descriptions of the individual functions used are given in the following pages.

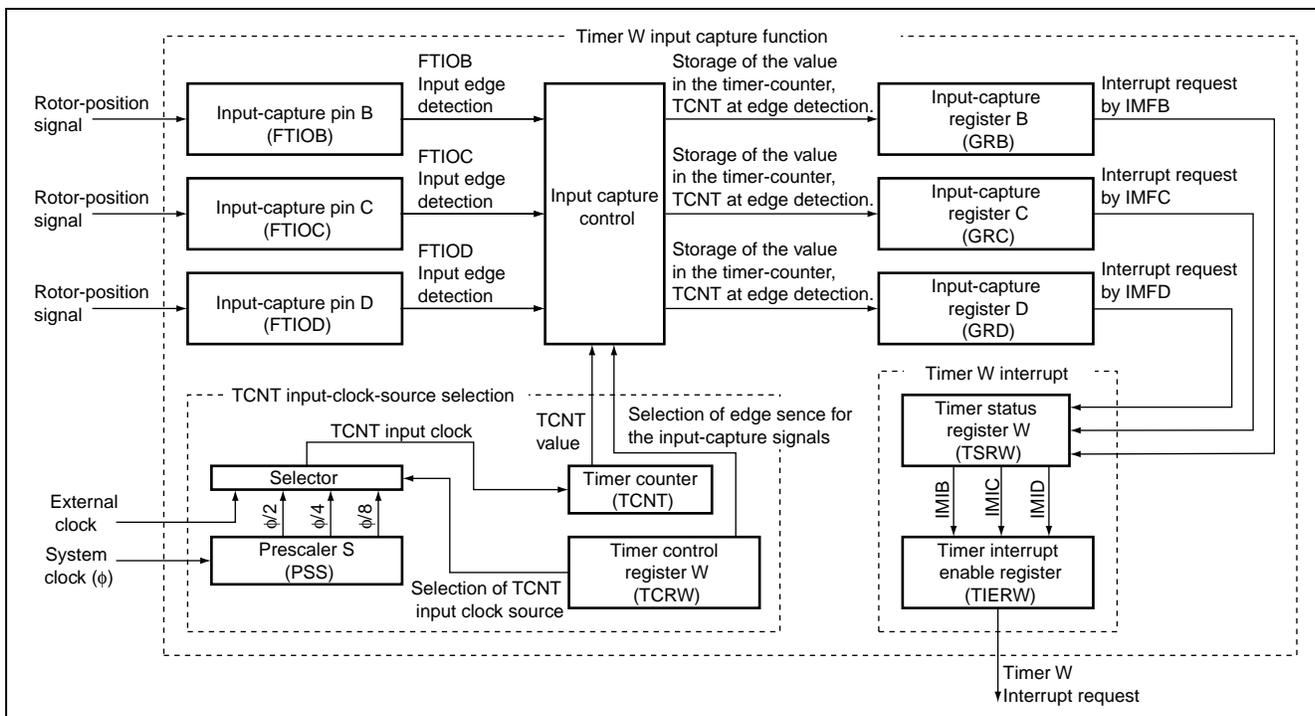
- 1) Two functions of Timer W are used: input capture, to generate interrupts in response to the rising and falling edges of the rotor-positional signal, and output comparison, to measure the magnetic-field rotation switching cycle in the initial stage of motor control.

The following functions are used in both the input capture and the output-comparison function of timer W.

- The system clock ( $\phi$ ) is the standard clock that drives the CPU and peripheral functions. Prescaler S (PSS) frequency-divides the system clock to obtain  $\phi/8192$  to  $\phi/2$  signals for sending to the various peripheral modules.
- PSS is a 13-bit counter with clock input of  $\phi$  and is incremented per clock cycle.
- The timer counter (TCNT) is a 16-bit readable/writable up-counter. The input clock is selectable from among four signals: those obtained by dividing the system-clock signal by 2, 4, and 8, and an external clock signal. The selection is made in TCRW (described below). In this sample task, the  $\phi/8$  signal is selected as the TCNT input clock.
- The timer control register (TCRW), an 8-bit readable/writable register, is used to select the input clock for TCNT.
- The timer status register (TSRW), an 8-bit register, controls each of the timer-driven interrupt-request signals.
- The timer interrupt enable register W (TIERW), an 8-bit readable/writable register, controls enabling/disabling of each of the timer-driven interrupt-request signals. In this sample task, interrupt requests by IMFA (IMIA), IMFB (IMIB), IMFC (IMIC), IMFD (IMID) are enabled.
- The timer I/O control registers (TIOR0, TIOR1) are used to select the functions of GRA, GRB, GRC and GRD, along with the edges for input captures B to D.

2) Timer W's input-capture function provides a way to generate interrupts on detecting the rising and falling edges of the rotor-positional signals. Figure 3.2 is a block diagram of how the input-capture function is used to generate interrupt requests in response to edges of the rotor-positional signal.

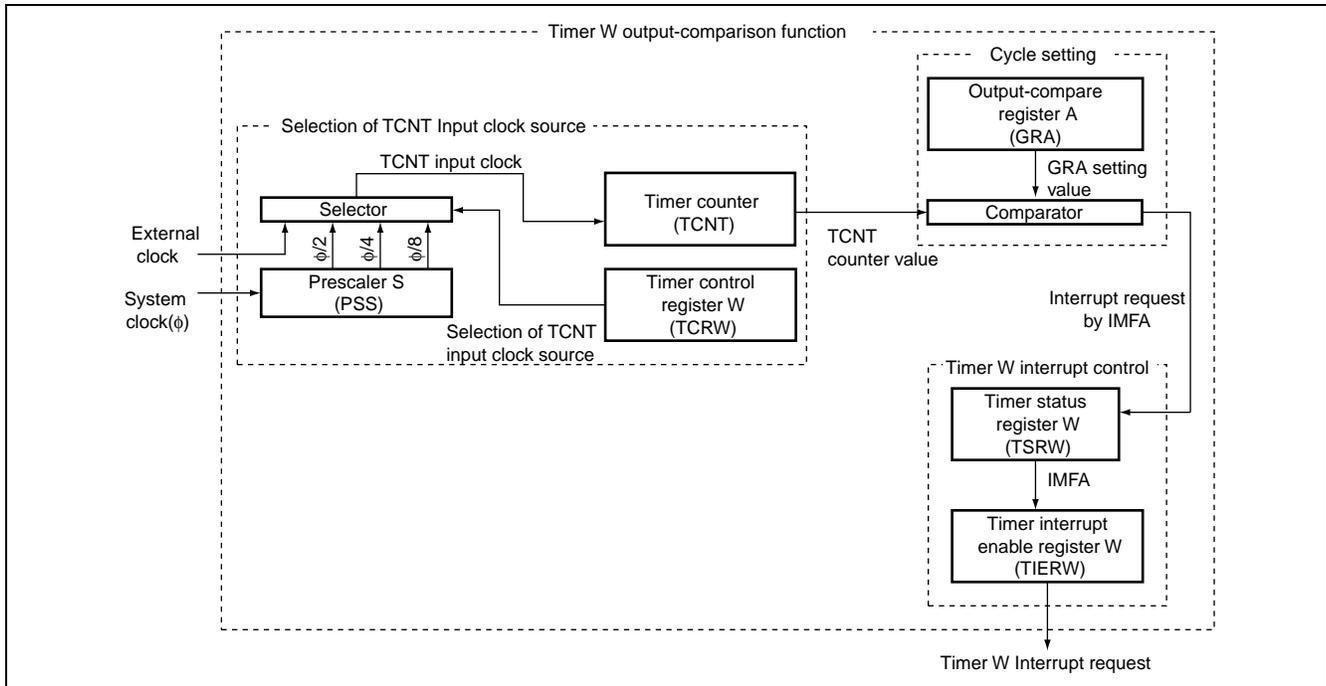
- The rotor-positional signal is input through input-capture pins B, C, and D (FTIOB, FTIOC, FTIOD).
- Input capture registers B, C, and D (GRB, GRC, GRD) are 16-bit readable/writable registers. When an edge is detected in input signal B, C or D, respectively, the value of TCNT is transferred to GRB, GRC or GRD, and IMFB, IMFC or IMFD of TSRW is set to "1". In this case, when the value of the corresponding IMIEB, IMIEC or IMIED bit in TIERW is "1", an interrupt request is sent to the CPU.



**Figure 3.2 Block Diagram of Interrupt Generation by the Input-capture Function in Response to Edges of the Rotor-positional Signal**

- 3) The timer W's output-comparison function is used to issue an interrupt request for the CPU at the end of every magnetic-field rotation switching cycle (i.e., at the intervals that correspond to 60 degrees at the motor's frequency of rotation) until the motor has gone through one rotation. Figure 3.3 is a block diagram of the control of these interrupt requests by timer W's output-comparison function. The operation of the blocks is described below.

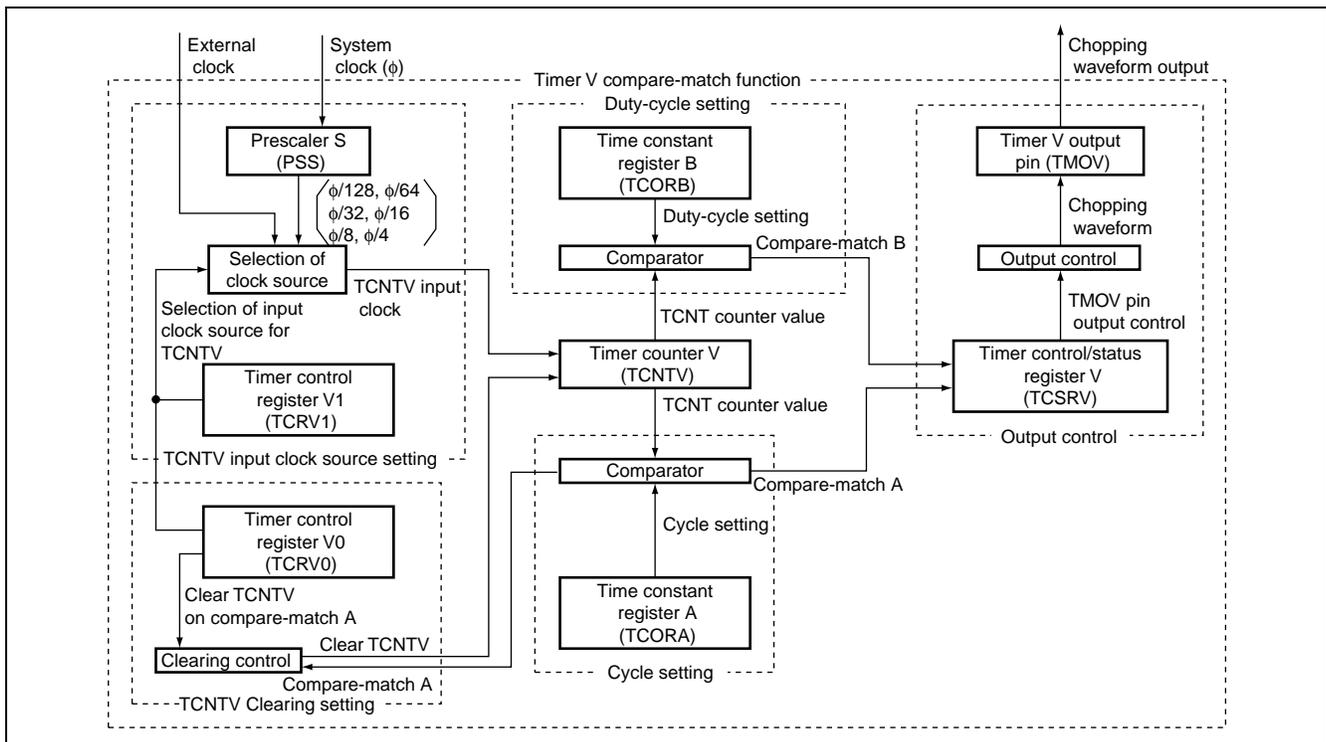
Output-compare register A (GRA) is a 16-bit readable/writable register. The content of GRA is constantly compared with TCNT. When the two values match, IMFA in TSRW is set to "1". In this case, if the IMIEA bit of TIERW is set to "1", an interrupt request is sent to the CPU.



**Figure 3.3 Block Diagram of Interrupt Generation per Magnetic-Field Switching Cycle by Timer W's Output-Comparison Function**

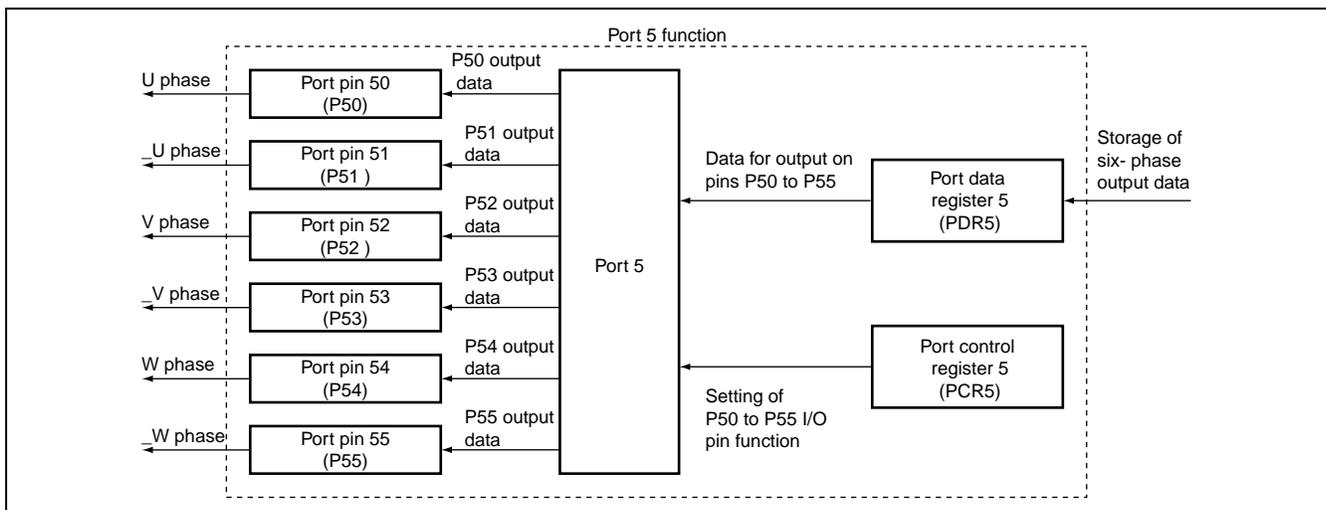
- 4) Timer V's compare-match function is used to generate the chopping waveform for output on the TMOV pin. Figure 3.4 is a block diagram of the control of chopping-waveform output by timer V's compare-match function. The operation of the blocks is described below.
- Timer Counter V (TCNTV), an 8-bit readable/writable up-counter, is incremented by either an internal or external clock input. The clock-source selection is made in bits CKS2 to CKS0 of the TCRV0 register. The value in TCNTV is always readable/writable from the CPU, and is cleared by the input of an external reset signal or by compare-match signal A or B. The clearing signal is selected by bits CCLR1 and CCLR0 of TCRV0.
  - Time Constant Registers A and B (TCORA, B) are 8-bit readable/writable registers. The contents of TCORA and B are constantly compared with the value in TCNTV; when either pair of values matches, the corresponding CMFA or B bit in TCSRv is set to "1". In this case, when CMIEA or B of TCSRv0 is "1", an interrupt is requested to the CPU. However, comparison is prohibited during the T3 state in the cycle of writing to the TCORA or B.

- Timer Control Register V0 (TCRV0), an 8-bit readable/writable register, is used to select the input clock, designate the signal that clears the TCNTV and enable interrupt requests. In this sample task, compare-match A is designated as the clearing signal. Selection of the input clock for TCNTV is made in combination with the ICKS0 bit of TCRV1.
- Timer Control/Status Register V (TCSRv), an 8-bit register, is used to set the compare-match flag and control output in response to a compare-match. In this sample task, output of "0" is selected for compare-match B and output of "1" is selected for compare-match A.
- Timer Control Register V1 (TCRV1), an 8-bit readable/writable register, is used to select the input clock for TCNTV.
- The chopping waveform is output from the timer V output pin (TMOV).



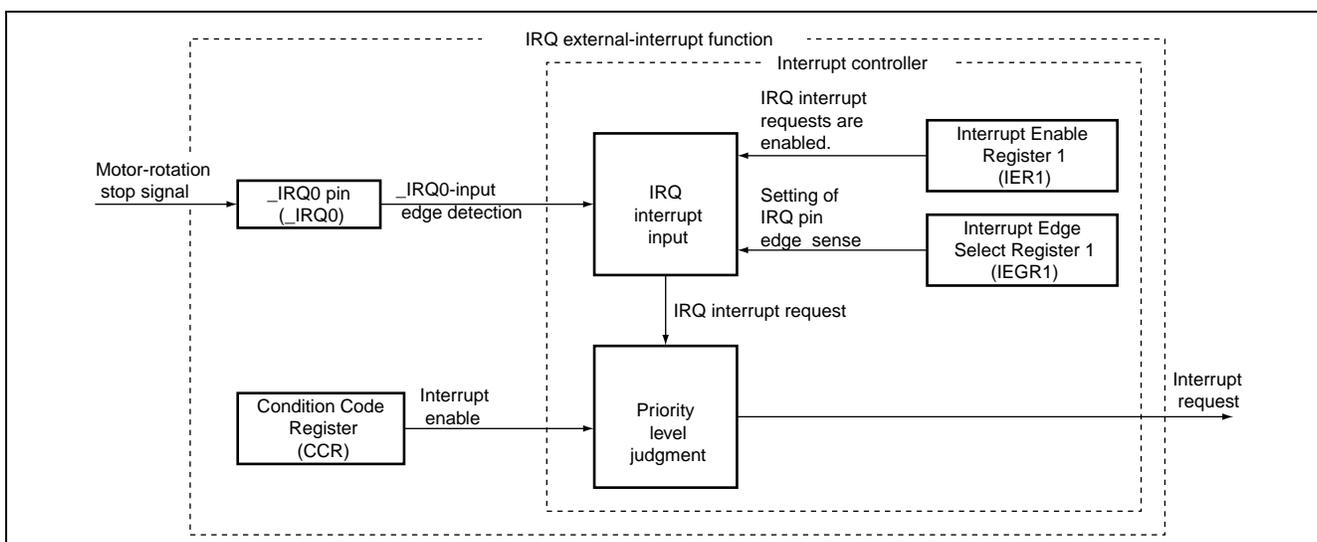
**Figure 3.4 Block Diagram of Chopping-Waveform Output through the Timer V Compare-Match Function**

- 5) The six driving signals are output through port 5. Figure 3.5 is a block diagram of six-phase control output through port 5.
- Port pin 50 (P50) acts as the output pin for the U phase of the motor driver.
  - Port pin 51 (P51) acts as the output pin for the  $\_U$  phase of the motor driver.
  - Port pin 52 (P52) acts as the output pin for the V phase of the motor driver.
  - Port pin 53 (P53) acts as the output pin for the  $\_V$  phase of the motor driver.
  - Port pin 54 (P54) acts as the output pin for the W phase of the motor driver.
  - Port pin 55 (P55) acts as the output pin for the  $\_W$  phase of the motor driver.
  - Port Register 5 (PDR5), the 8-bit data register for port 5, is used to store the data for each of pins P50 – P56. When the value in a bit of the port 5 control register (PCR5) is "1", the value read from the data bit is that of the corresponding bit in PDR5. Therefore, PDR5 is not affected by the pin states. When the value in a bit of PCR5 is "0", the corresponding pin is an input pin and the value read is its state.
  - Port Control Register (PCR5) provides bit-by-bit control of the input/output state of each of pins P50 to P56 on port 5. In this sample task, pins P50 to P56 are set as output pins.



**Figure 3.5 Block Diagram of Six-Phase Drive Output on Port 5**

- 6) The IRQ external interrupt line is used to detect the motor-rotation stop signal. Figure 3.6 is a block diagram of how the IRQ external interrupt function is used to handle this signal. The operation of the blocks is described below.
- The \_IRQ0 pin is used as the input pin for the externally generated motor-rotation stop signal.
  - An IRQ0 interrupt is requested in response to the input of an edge on the \_IRQ0 pin. Rising or falling may be selected as the edge sense of the \_IRQ0 pin.
  - Interrupt Edge Select Register 1 (IEGR1) is an 8-bit readable/writable register used to designate rising- or falling-edge detection by the \_IRQ0 pin.
  - Interrupt Enable Register 1 (IENR1) is an 8-bit readable/writable register for the enabling and disabling of interrupts. In this sample task, IRQ0 interrupt requests are enabled and timer A, IRQ1, IRQ2, and IRQ3 interrupts are disabled.
  - Interrupt Request Register 1 (IRR1) is an 8-bit readable/writable register of interrupt flags. When a timer A, or IRQ0, ..., IRQ3 interrupt is generated, the corresponding flag is set to "1". Interrupt-request flags are not automatically cleared, even by acceptance of the interrupt. Write a "0" to clear any of the interrupt-request flags.



**Figure 3.6 Block Diagram of the Use of the IRQ External-Interrupt Function to Detect the Motor-Rotation Stop Signal**

3. Table 3.1 lists the assignment of functions to H8/3664 elements for this sample task, i.e., control of the brushless DC motor.

**Table 3.1 H8/3664 Function Assignment**

<b>H8/3664 Element</b>	<b>Assigned Function</b>
FTIOB, C, D	<ul style="list-style-type: none"> <li>• Rotor-positional signal input</li> </ul>
TCNT	<ul style="list-style-type: none"> <li>• 16-bit up-counter (input clock source is selected in TCRW)</li> </ul>
TCRW	<ul style="list-style-type: none"> <li>• Clock source setting for TCNT</li> <li>• Selection of the counter-clearing signal for TCNT</li> </ul>
GRA	<ul style="list-style-type: none"> <li>• Selection of the initial switching period for the motor's rotating magnetic field</li> </ul>
TSRW	<ul style="list-style-type: none"> <li>• Reflects the sources of timer W interrupt requests (IMFA, IMFB, IMFC, IMFD)</li> </ul>
TIERW	<ul style="list-style-type: none"> <li>• Enables/disables interrupt requests (IMFA, IMFB, IMFC, IMFD) from timer W</li> </ul>
TMOV	<ul style="list-style-type: none"> <li>• Chopping waveform output</li> </ul>
TCNTV	<ul style="list-style-type: none"> <li>• 8-bit up-counter</li> </ul>
TCORA	<ul style="list-style-type: none"> <li>• Setting of the period for the chopping waveform</li> </ul>
TCORB	<ul style="list-style-type: none"> <li>• Setting of the duty cycle for the chopping waveform</li> </ul>
TCRV0	<ul style="list-style-type: none"> <li>• Set TCNTV input clock source</li> <li>• Set TCNTV clearing condition</li> <li>• Enable/disable of timer V interrupt request (CMIA, CMIB)</li> </ul>
TCRV1	<ul style="list-style-type: none"> <li>• Setting of the input clock source for TCNTV</li> </ul>
TCSR	<ul style="list-style-type: none"> <li>• Reflects the sources of timer V interrupt requests (CMIA, CMIB)</li> <li>• Selection of the output values for compare-match operations</li> </ul>
P50 to P55	<ul style="list-style-type: none"> <li>• Six-phase waveform output</li> </ul>
PCR5	<ul style="list-style-type: none"> <li>• Setting of pin functions for P50–P55</li> </ul>
PDR5	<ul style="list-style-type: none"> <li>• Storage of data for output on pins P50–P55</li> <li>• Read to determine pin levels</li> </ul>
_IRQ0	<ul style="list-style-type: none"> <li>• Motor-rotation stop signal input</li> </ul>
IEGR1	<ul style="list-style-type: none"> <li>• Selection of the input edge for detection by _IRQ0</li> </ul>
IER1	<ul style="list-style-type: none"> <li>• Reflects the presence of the IRQ0 interrupt</li> </ul>

### 4. Description of Operation

1. Figure 4.1 shows the principal of operation in initial motor control (until the motor has gone through its first rotation, switching of the rotating magnetic-field takes place at a constant period). Initial control of the brushless DC motor is through hardware and software processing by the H8/3664 as shown in figure 4.1.

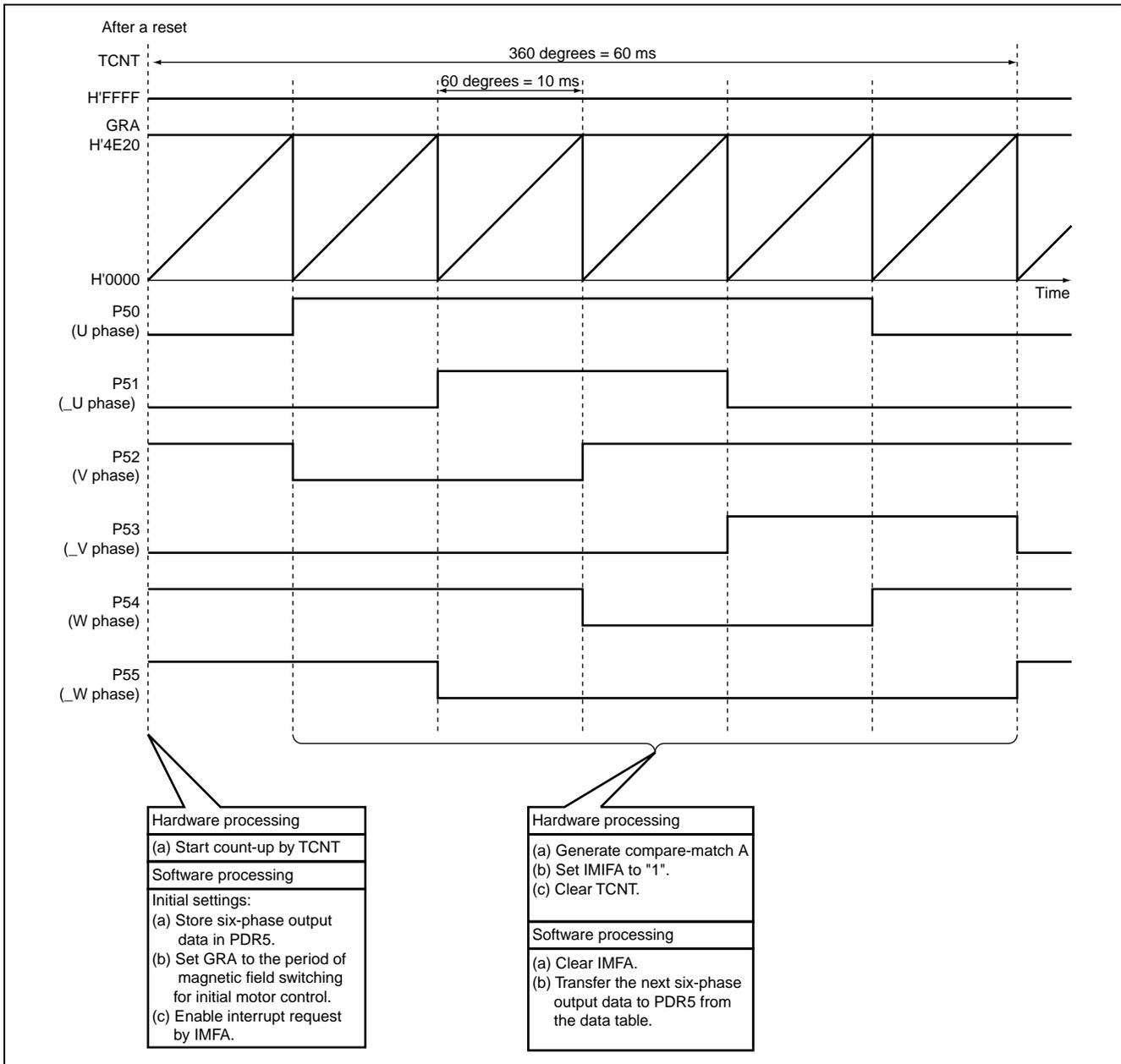


Figure 4.1 Initial Control of the Brushless DC Motor: Principle of Operation

2. Figure 4.2 shows the principle of control to make the magnetic field rotate in response to the rotor-positional signal. Control of the brushless DC motor is through hardware and software processing by the H8/3664, based on the detected rotor-positional signal, as is shown in figure 4.2.

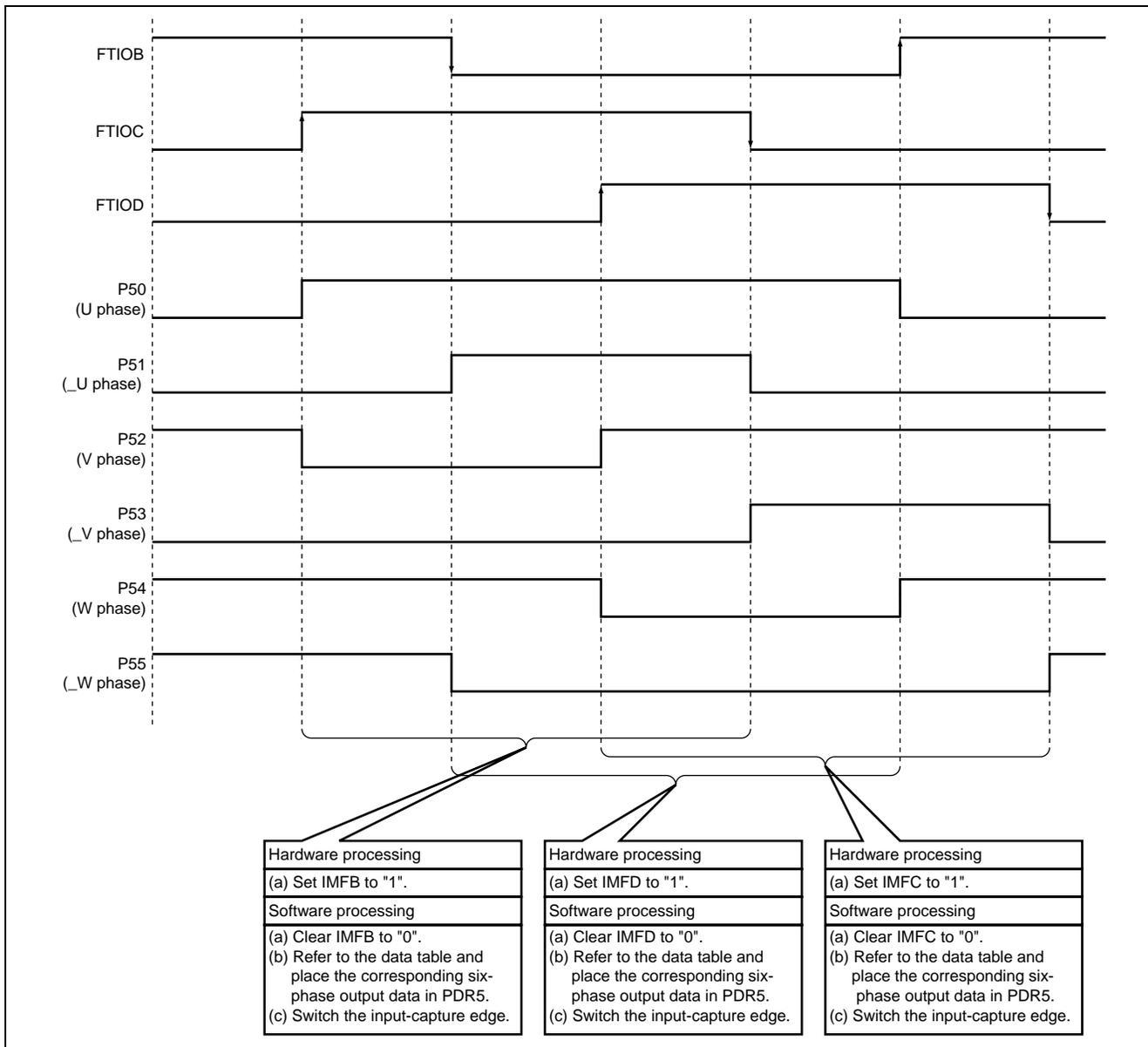
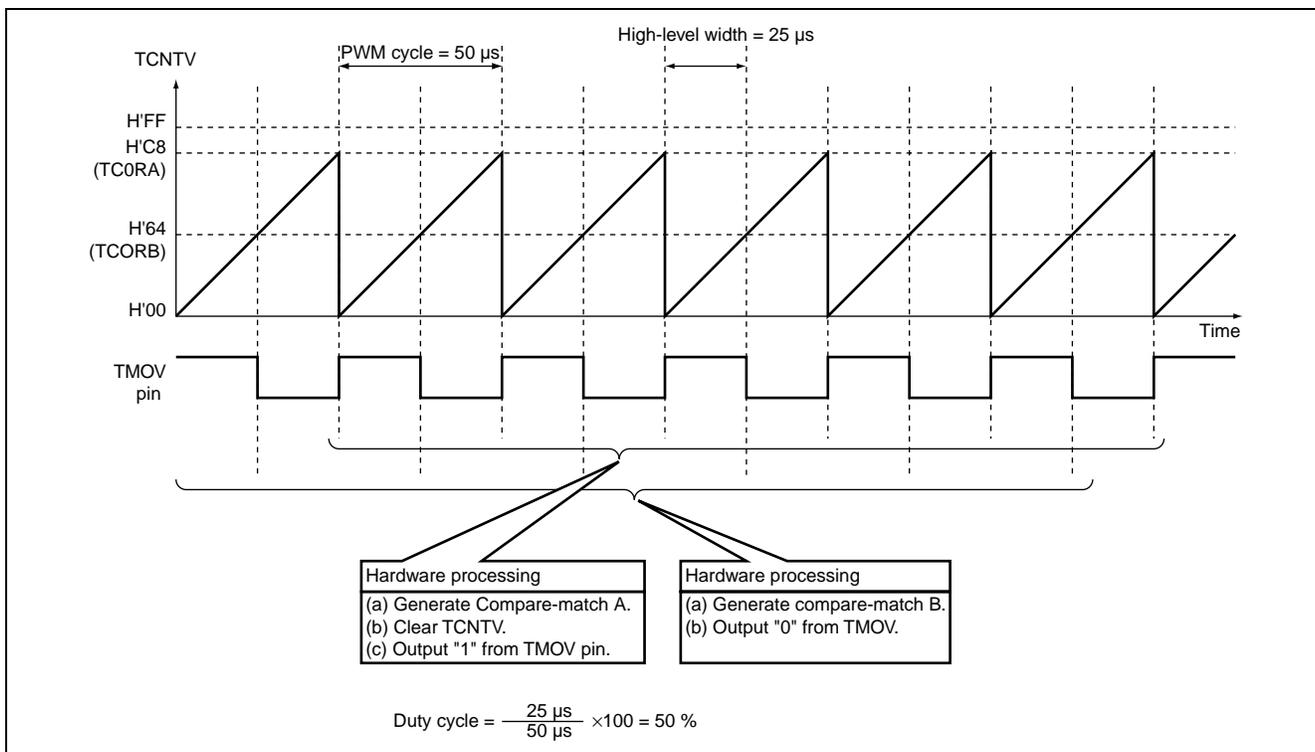


Figure 4.2 Principle of Motor Control Based on the Rotor-Positional Signal

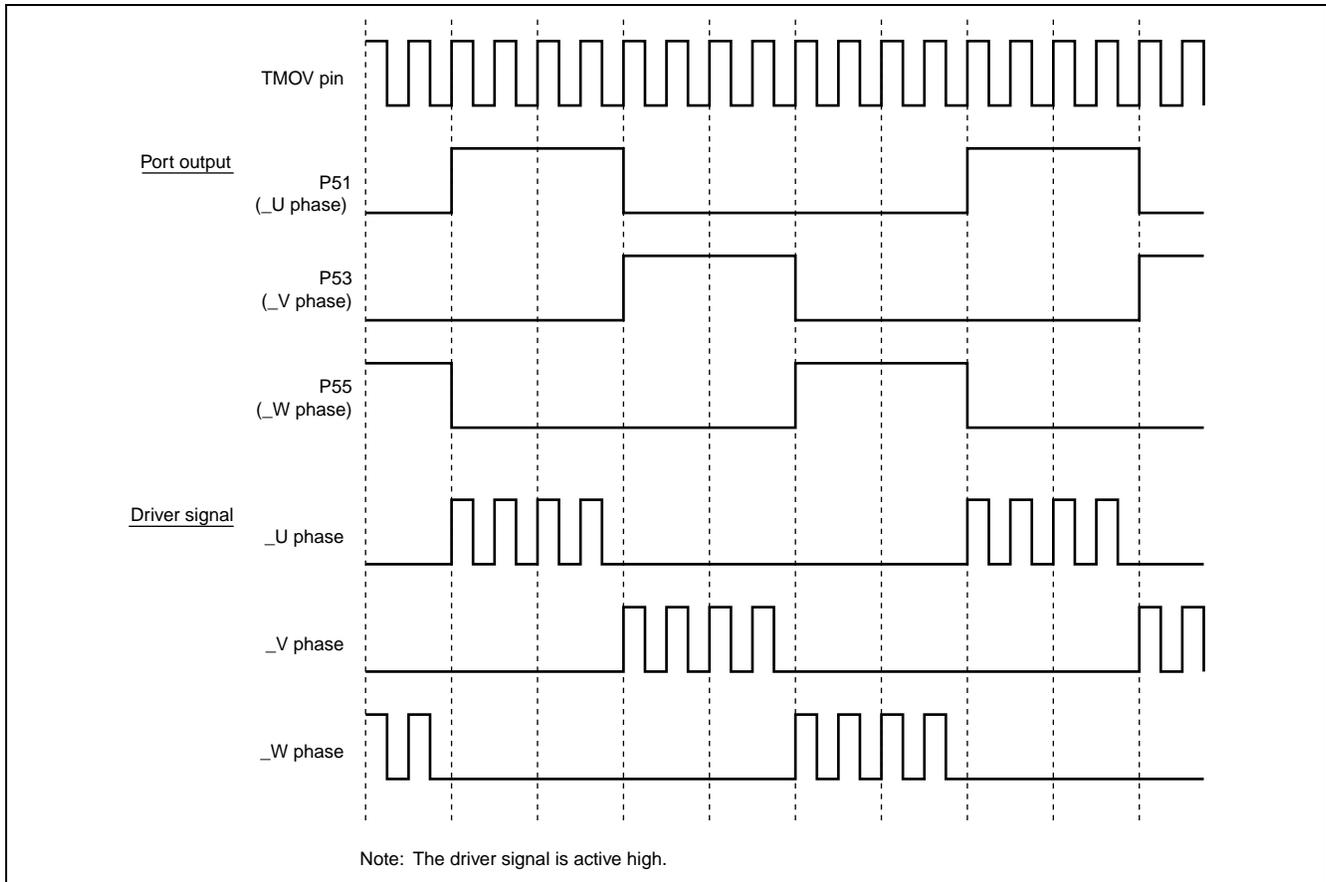
3. In this sample task, chopping control is applied when the driver transistors on the negative-phase side are turned on. A chopping waveform generated by the timer V compare-match function is output on the TMOV pin. Figure 4.3 shows the principle of operation for output of the chopping waveform.



**Figure 4.3 Output of the Chopping Waveform: Principle of Operation**

In this sample task, a duty cycle of 50% is selected by the period setting of H'C8 in TCORA (50 μs) and the high-level width setting of H'64 in TCORB (25 μs).

4. The external AND circuits on the inverse-phase signals of the six-phase control output obtain the logical AND of the chopping waveform (on the TMOV pin) and magnetic-field rotation waveforms (port output) for output to the driver. Figure 4.4 shows the principle of operation applied to obtain the AND of the chopping and rotating-field waveforms.



**Figure 4.4 Taking the AND of the Inverse-Phase Port-Output Signals and the TMOV Output: Principle of Operation**

## 5. Description

### 5.1 Description of Modules

Table 5.1 describes the software used in this sample task.

**Table 5.1 Description of Modules**

Module Name	Label Name	Function
Main routine	main	Initializes the stack pointer, sets up the IRQ <sub>0</sub> interrupt, starts counting by the timer, and sets up the individual interrupts.
Initialization	IO_INIT	Initializes the registers to be used, sets up timer W output comparison, timer V output comparison and the RAM used.
Timer W interrupt processing routine	intpt_tmw	Checks the source of a timer W interrupt and calls the appropriate routine for six-phase output control.
Initial motor control routine	tmw_3	Switches the rotating magnetic field on a constant cycle until the motor has gone through one rotation.
Feedback-driven routine to drive switching to produce the rotating-field signals (FTIOB)	SA_1	Switches the excited phase according to the rotor position detection signal which is output to the FTIOB pin from the motor.
Rotating-field switching routine by feedback signal (FTIOC)	SB_1	Switches the excited phase by rotor position detection signal which is output to the FTIOC pin from the motor.
Rotating-field switching routine by feedback signal (FTIOD)	SC_1	Switches the excited phase by rotor position detection signal which is output to the FTIOD pin from the motor.
IRQ <sub>0</sub> interrupt processing routine	r_stop	As the IRQ <sub>0</sub> interrupt handler, stops the motor by clearing the interrupt request flag and setting the error flag.

### 5.2 Description of Arguments

No arguments are used in this sample task.

### 5.3 Description of Internal Registers

Table 5.2 describes the internal registers used in this sample task.

**Table 5.2 Description of Internal Registers**

Register Name	Function	Address	Setting	
PDR5	Port Data Register 5: When P5n is "0", the level on pin P5n is "Low".(n=0 to 7) When P5n is "1", the level on pin P5n is "High".(n=0 to 7)	H'FFD8	H'00	
PCR5	Port Control Register 5: When PCR5n is "0", pin P5n acts as an input pin. (n=0 to 7) When PCR5n is "1", pin P5n acts as an output pin. (n=0 to 7)	H'FFE8	H'FF	
TSRW	IMFA	Timer Control/Status Register (Compare-match Flag A): When IMFA is "0", compare-match A has not been generated. When IMFA is "1", compare-match A has been generated.	H'FF83 Bit 0	0
	IMFB	Timer Control/Status Register (Input Capture Flag B): When IMFB is "0", compare-match B has not been generated. When IMFB is "1", compare-match B has been generated.	H'FF83 Bit 1	0
	IMFC	Timer Control / Status Register (Input Capture Flag C): When IMFC is "0", compare-match C has not been generated. When IMFC is "1", compare-match C has been generated.	H'FF83 Bit 2	0
	IMFD	Timer Control / Status Register (Input Capture Flag D): When IMFD is "0", compare-match D has not been generated. When IMFD is "1", compare-match D has been generated.	H'FF83 Bit 3	0

Table 5.2 Description of Internal Registers (cont)

Register Name	Function	Address	Setting
TIERW	IMIEA Timer Interrupt Enable Register (Compare-match Interrupt Enable A): When IMIEA is "0", IMFA interrupt requests are disabled. When IMIEA is "1", IMFA interrupt requests are enabled.	H'FF82 Bit 0	1
	IMIEB Timer Interrupt Enable Register (Input Capture Interrupt Enable B): When IMIEB is "0", IMFB interrupt requests are disabled. When IMIEB is "1", IMFB interrupt requests are enabled.	H'FF82 Bit 1	0
	IMIEC Timer Interrupt Enable Register (Input Capture Interrupt Enable C): When IMIEC is "0", IMFC interrupt requests are disabled. When IMIEC is "1", IMFC interrupt requests are enabled.	H'FF82 Bit 2	0
	IMIED Timer Interrupt Enable Register (Input Capture Interrupt Enable D): When IMIED is "0", IMFD interrupt requests are disabled. When IMIED is "1", IMFD interrupt requests are enabled.	H'FF82 Bit 3	0
TIOR0	IOA0 I/O Control A1 to 0	H'FF84	IOA0=0
	IOA1 If IOA2 is "0": When A1 and A0 are "00", no output on compare match.	Bit 0 Bit 1	IOA1=0
	IOA2 I/O Control A2: When IOA2 is "0", GRA functions as an output-compare register. When IOA2 is "1", GRA functions as an input-capture register.	H'FF84 Bit 2	0
	IOB0 I/O Control B1 to 0	H'FF84	IOB0=1
	IOB1 If IOB2 is "1": When B1 and B0 are "00", input capture is made by GRB on the rising edge of the FTIOB signal. When B1 and B0 are "01", input capture is made by GRB on the rising edge of the FTIOB signal.	Bit 4 Bit 5	IOB1=0
	IOB2 I/O Control B2: When IOB2 is "0", GRB functions as an output-compare register. When IOB2 is "1", GRB functions as an input-capture register.	H'FF84 Bit 6	1*

Table 5.2 Description of Internal Registers (cont)

Register Name	Function	Address	Setting	
TIOR1	IOC0	I/O Control C1 to 0	H'FF85	IOC0=0
	IOC1	When IOC2 is "1": When IOC1 and IOC0 are "00", input capture is made by GRC on the rising edge of the FTIOC pin. When IOC1 and IOC0 are "01", input capture is made by GRC on the falling edge of the FTIOC pin.	Bit 0 Bit 1	IOC1=0
IOC2	IOC2	I/O Control C2: When IOC2 is "0", GRC functions as an output-compare register. When IOC2 is "1", GRC functions as an input-capture register.	H'FF85 Bit 2	1*
	IOD0	I/O Control D1 to 0	H'FF85	IOD0=1
IOD1	IOD1	When IOD2 is "1": When IOD1 and IOD0 are "00", input capture is made by GRD on the rising edge of the FTIOD pin. When IOD1 and IOD0 are "00", input capture is made by GRD on the falling edge of the FTIOD pin.	Bit 4 Bit 5	IOD1=0
	IOD2	I/O Control D2: When IOD2 is "0", GRD functions as an output-compare register. When IOD2 is "1", GRD functions as an input-capture register.	H'FF85 Bit 6	1*
GRA	General Register A The register is used as the output-compare register and is constantly compared with the value in TCNT. When the two values match (compare-match), the IMFA flag of TSRW is set to "1".	H'FF88	H'4E20	
GRB	General Register B The register is used as an input-capture register. When the input capture signal from FTIOB is detected, the value of TCNT is stored; the IMFB flag of TSRW is then set to "1".	H'FF8A	H'0000	
GRC	General Register C The register is used as an input capture register. When the input capture signal is detected from FTIOC, the value of TCNT is stored, then IMFC flag of TSRW is set in "1".	H'FF8C	H'0000	
GRD	General Register D The register is used as an input capture register. When the input capture signal is detected from FTIOD, the value of TCNT is stored, then IMFD flag of TSRW is set in "1".	H'FF8E	H'0000	

Table 5.2 Description of Internal Registers (cont)

Register Name	Function	Address	Setting	
TCSRV	OS0	Timer Control/Status Register V	H'FFA1	OS1=1
	OS1	(Output select 1 to 0):	Bit 0	OS0=0
		When OS1 and OS0 are "01", "0" is output from the TMOV pin when comparison of TCORA and TCNTV produces a match. When OS1 and OS0 are "01", "1" is output from the TMOV pin when comparison of TCORA and TCNTV produces a match.	Bit 1	
	OS2	Timer Control/Status Register V	H'FFA1	OS2=1
OS3	(Output select 3 to 2):	Bit 2	OS3=0	
	When OS3 and OS2 are "01", "0" is output from the TMOV pin when comparison of TCORB and TCNTV produces a match. When OS3 and OS2 are "01", "1" is output from the TMOV pin when comparison of TCORB and TCNTV produces a match.	Bit 3		
TCRV0	CCLR0	Counter Clear 1, 0:	H'FFA0	CCLR0=0
	CCLR1	When CCLR1 and CCLR0 are "01", TCNTV is cleared by compare-match A. When CCLR1 and CCLR0 are "10", TCNTV is cleared by compare-match B.	Bit 0 Bit 1	CCLA1=1
TCORA	Time Constant Register A: When TCORA is "H'C8", compare-match A occurs when TCNTV is incremented to H'C8.	H'FFA2	H'C8	
TCORB	Time Constant Register B: When TCORB is "H'64", compare-match B occurs when TCNTV is incremented to H'64.	H'FFA3	H'64	
IEGR1	IEG0	Interrupt edge select register 1 (IRQ0 edge select): When IEG0 is "0", falling edges in the IRQ0 pin's input are detected. When IEG0 is "1", rising edges in the IRQ0 pin's input are detected.	H'FFF2 Bit 0	0
IENR1	IEN0	Interrupt enable register 1 (IRQ0 interrupt enable): When IEN0 is "0", IRQ0 interrupt requests are disabled. When IEN0 is "1", IRQ0 interrupt requests are enabled.	H'FFF4 Bit 0	0
IRR1	IRRI0	Interrupt request register 1 (IRQ0 interrupt request flag): "0" indicates that an IRQ0 interrupt request has not been generated. "1" indicates that an IRQ0 interrupt request has been generated.	H'FFF6 Bit 0	0

Note: \* This value is initially "0".

## 5.4 Description of RAM Usage

Table 5.3 describes the RAM locations used in this sample task.

**Table 5.3 Description of RAM Usage**

Label Name	Function	Address	Label Name of Using Module
x	Counter for reference data table in initial motor control	H'FB80	IO_INIT
y	Counter for change of timer function	H'FB81	IO_INIT

## 5.5 Description of Data Table

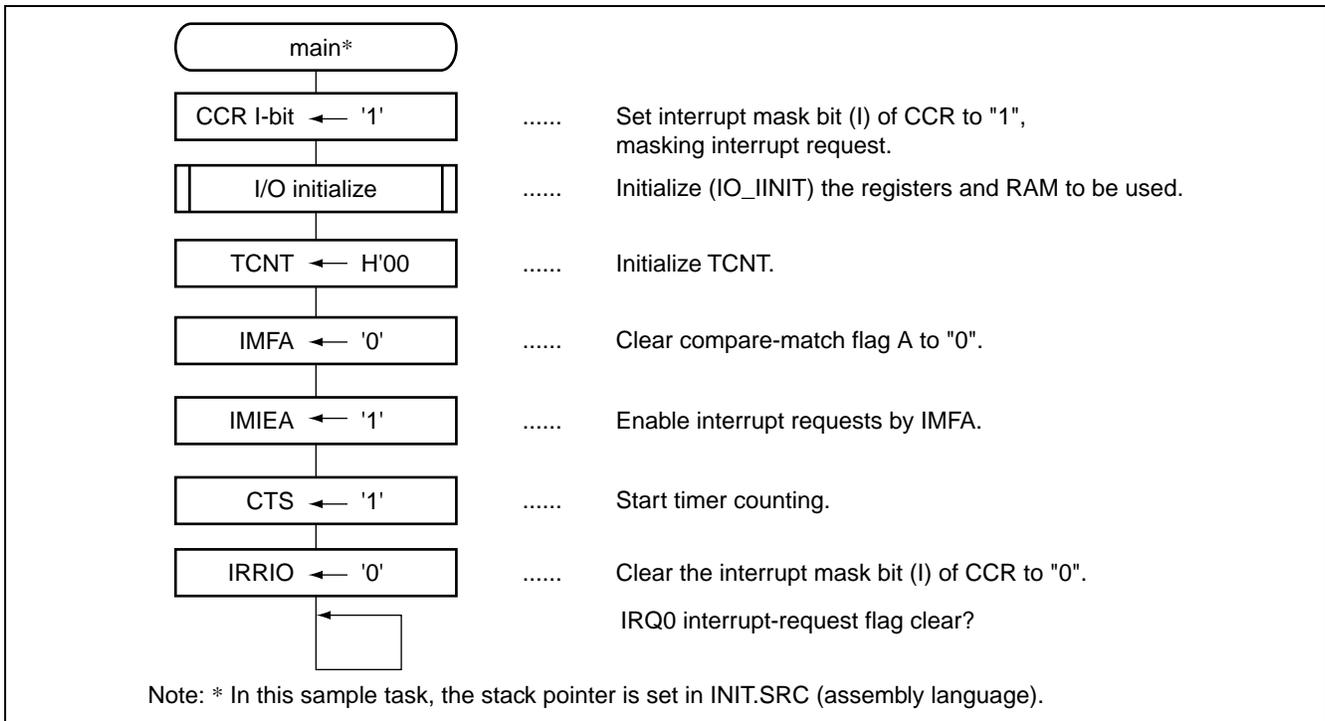
In this sample task, six patterns data on the table are output from port 5 at initial motor control. Table 5.4 shows the description of data table.

**Table 5.4 Description of Data Table (data\_0)**

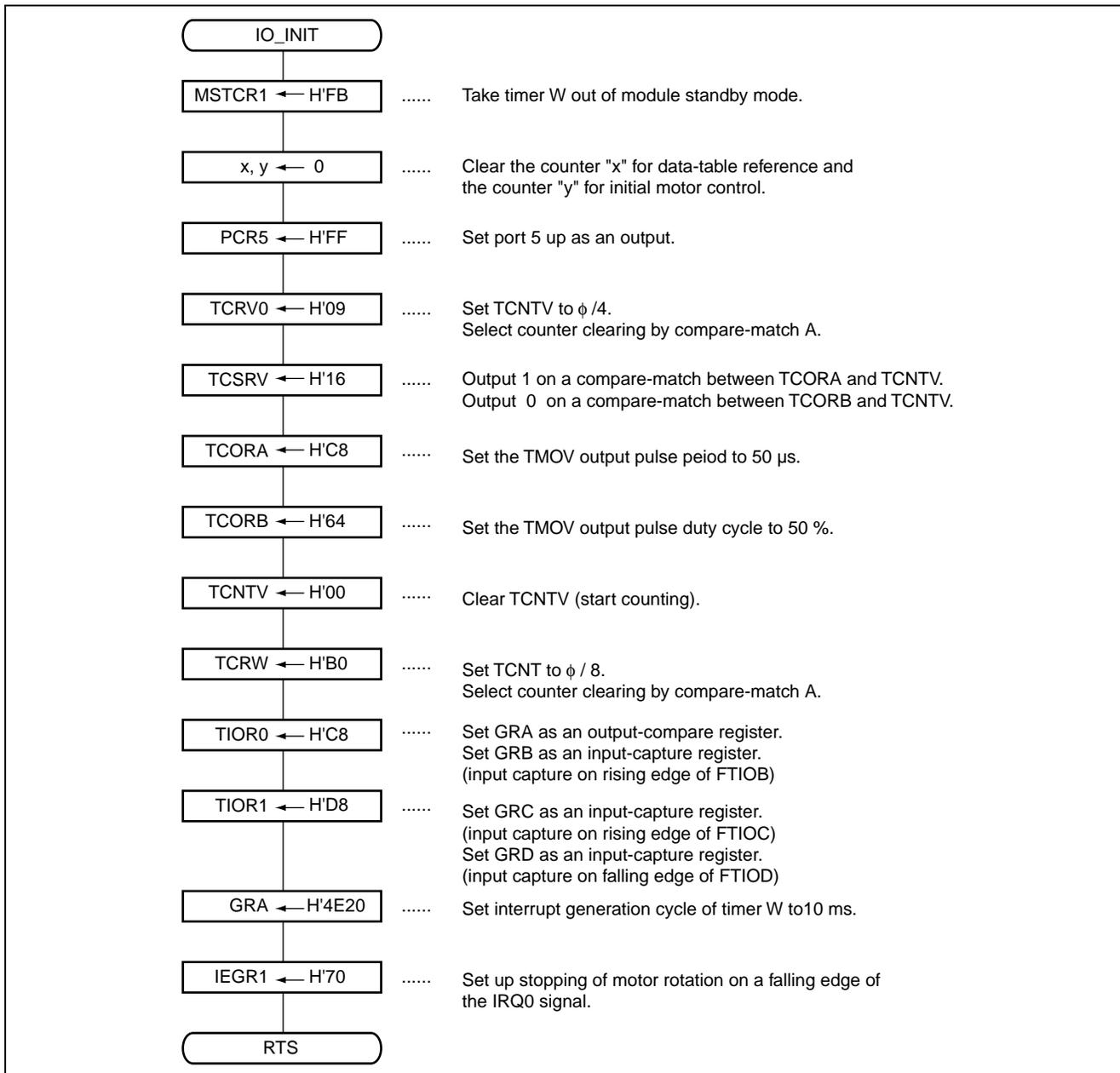
Data Name	Data	Output Pattern	Size	Address
data_0[0]	H'34	U = L, _U = L, V = H, _V = L, W = H, _W = H	1 byte	H'02D6
data_0[1]	H'31	U = H, _U = L, V = L, _V = L, W = H, _W = H	1 byte	H'02D7
data_0[2]	H'13	U = H, _U = H, V = L, _V = L, W = H, _W = L	1 byte	H'02D8
data_0[3]	H'07	U = H, _U = H, V = H, _V = L, W = L, _W = L	1 byte	H'02D9
data_0[4]	H'0D	U = H, _U = L, V = H, _V = H, W = L, _W = L	1 byte	H'02DA
data_0[5]	H'1C	U = L, _U = L, V = H, _V = H, W = H, _W = L	1 byte	H'02DB

## 6. Flowchart

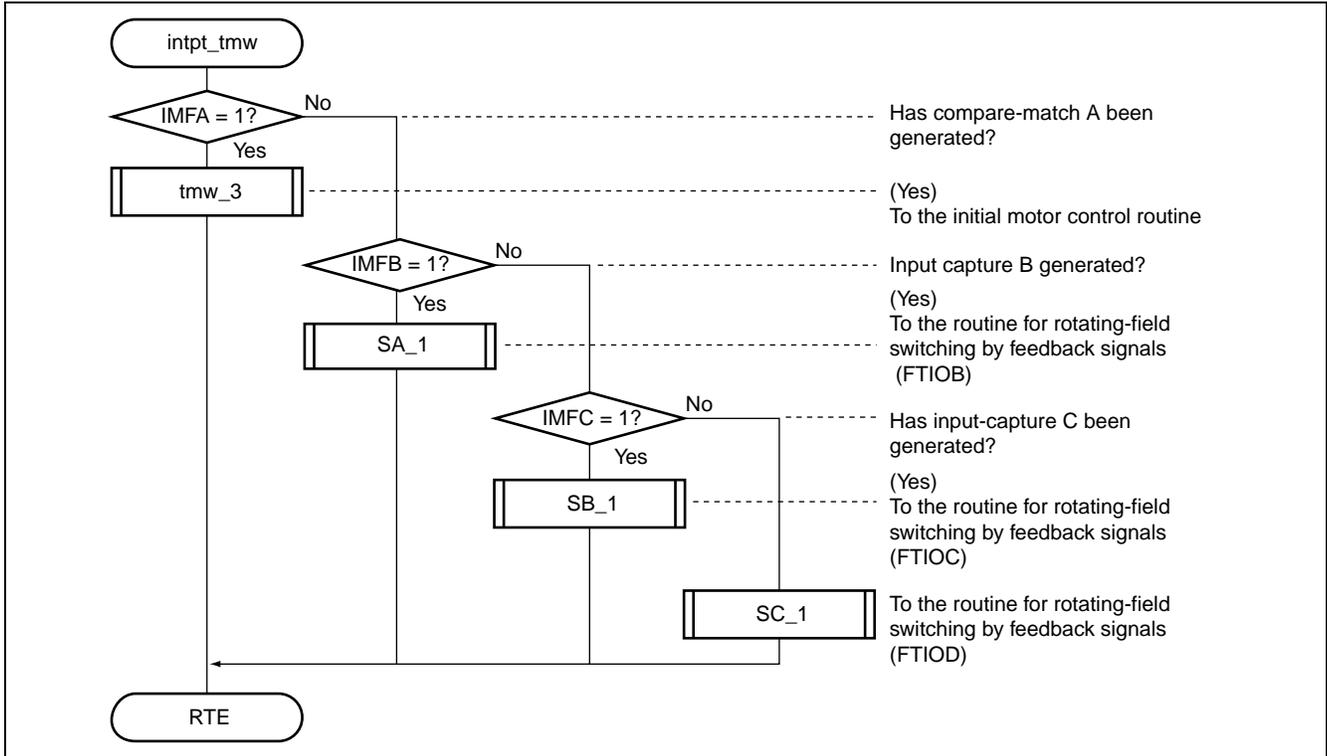
### 1. Main routine



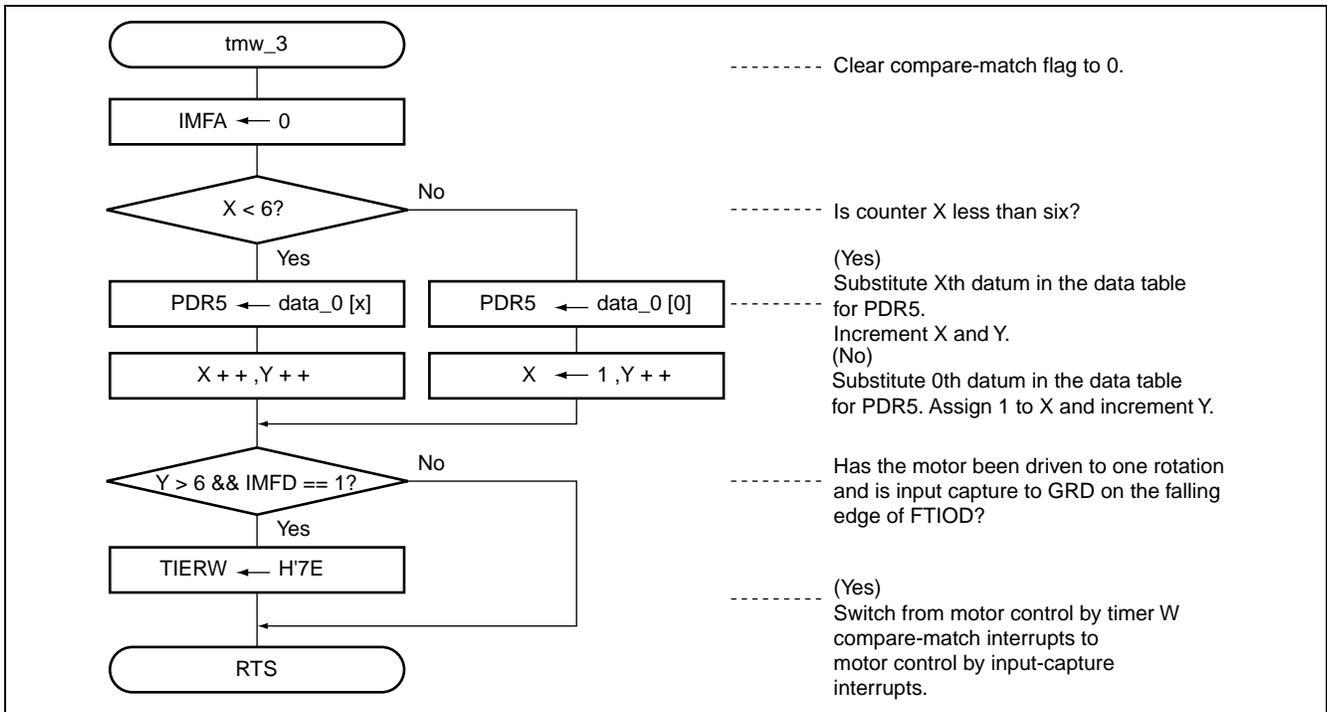
## 2. Register initialization routine



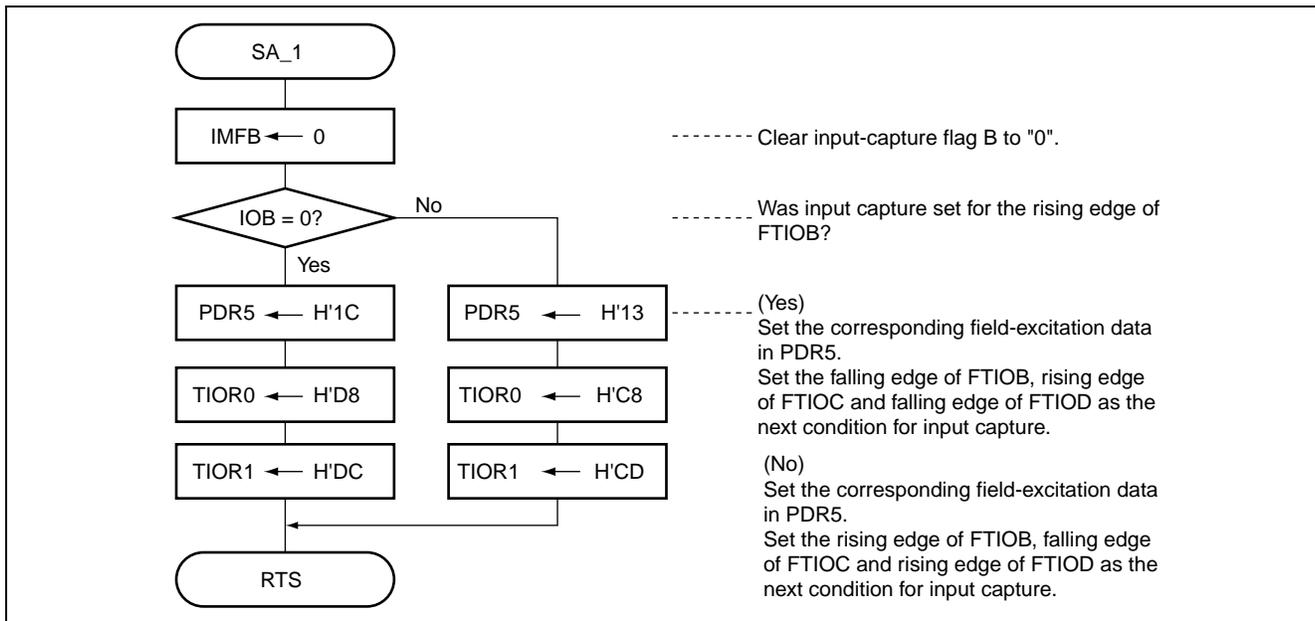
3. Timer W interrupt process



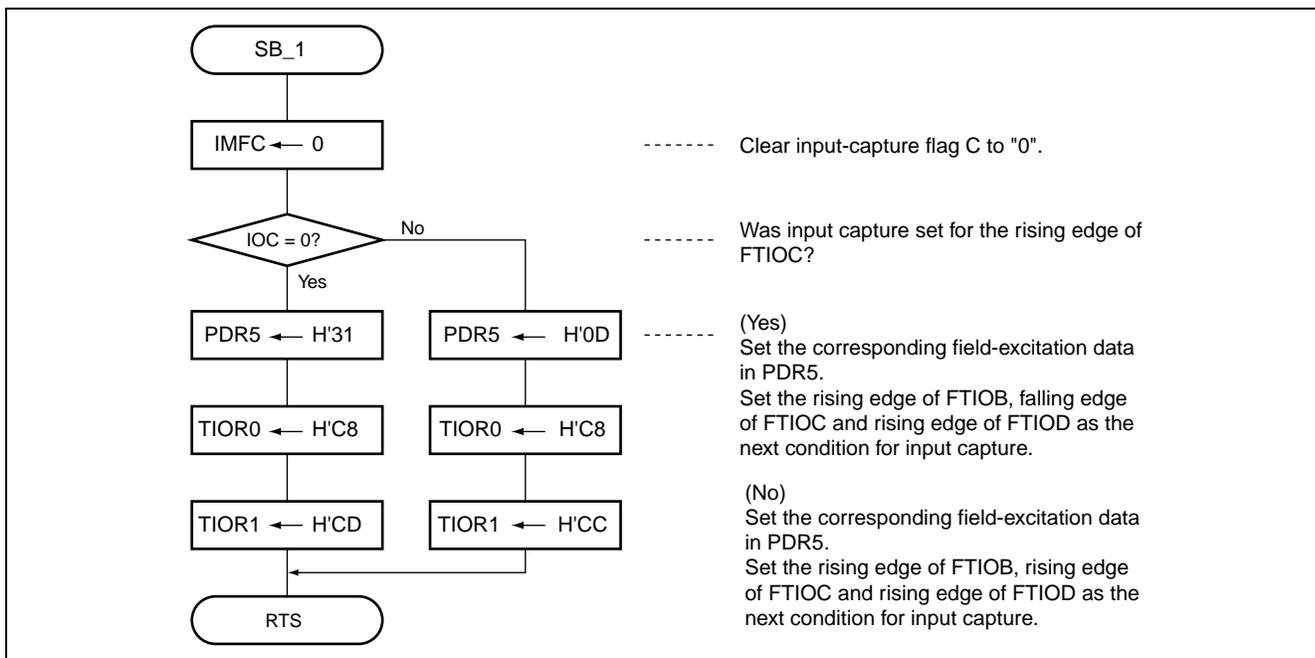
4. Initial motor control



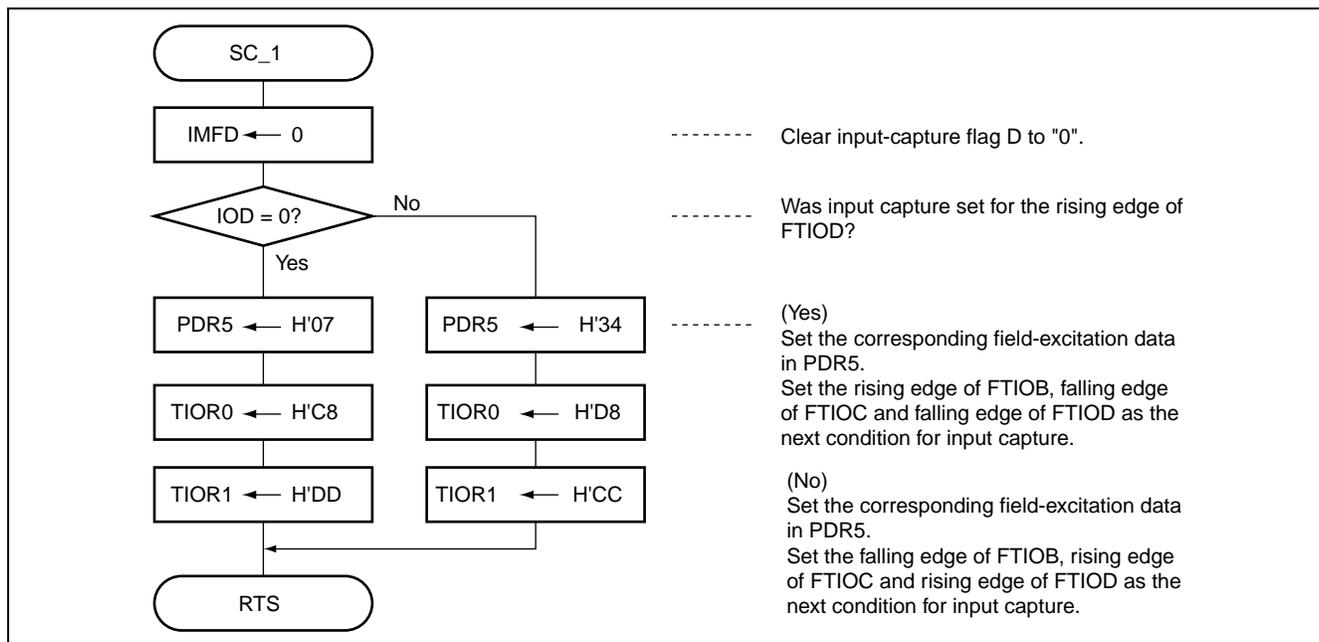
5. Rotating-field switching routine by feedback signal (FTIOB)



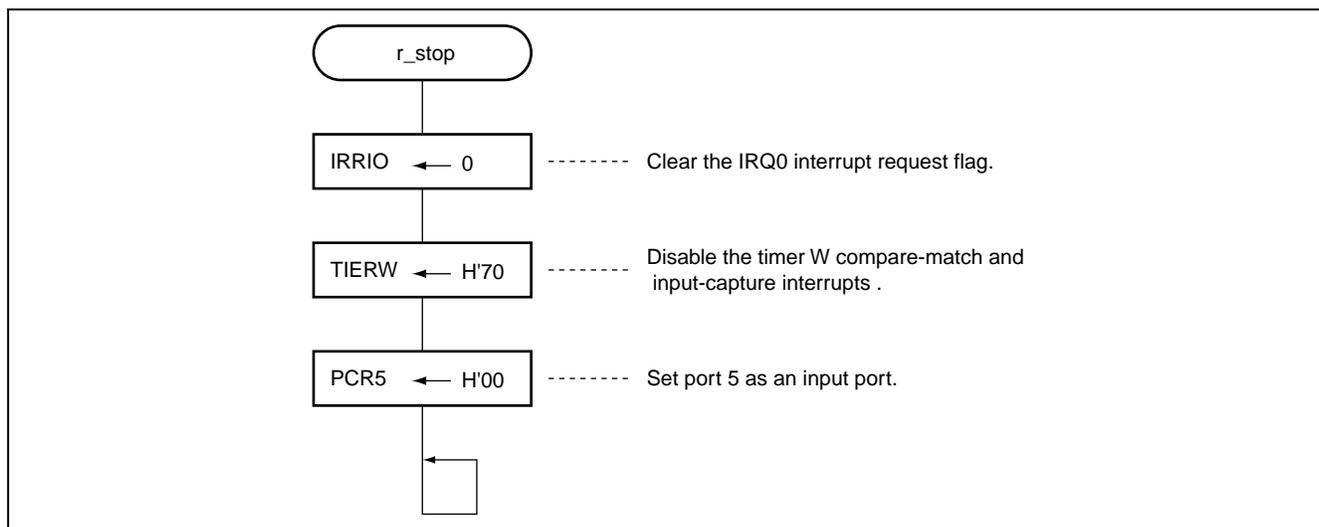
6. Rotating-field switching routine by feedback signal (FTIOC)



7. Rotating-field switching routine by feedback signal (FTIOD)



8. Motor-rotation stop signal detection



## 7. Program Listing

### INIT.SRC (Program listing)

```

        .EXPORT_INIT
        .IMPORT_main
;
        .SECTION      P, CODE
_INIT:
        MOV.W   #H'FF80, R7
        LDC.B   #B'10000000, CCR
        JMP     @_main
;
        .END

/* H8/300H Tiny Series -H8/3664- Application Note                                */
/* Applied chapter-3                                                            */
/* Control of Brushless DC Motor                                              */
#include <machine.h>

/* Symbol Definition                                                            */

struct BIT {
    unsigned char    b7:1;
    unsigned char    b6:1;
    unsigned char    b5:1;
    unsigned char    b4:1;
    unsigned char    b3:1;
    unsigned char    b2:1;
    unsigned char    b1:1;
    unsigned char    b0:1;
};

#define    TMRW        *(volatile unsigned char *)0xFF80        /* Timer W */
#define    TMRW_BIT    (*(struct BIT *)0xFF80)
#define    CTS        TMRW_BIT.b7
#define    TCRW        *(volatile unsigned char *)0xFF81
#define    TIERW        *(volatile unsigned char *)0xFF82
#define    TIERW_BIT    (*(struct BIT *)0xFF82)
#define    IMIED        TIERW_BIT.b3
#define    IMIEC        TIERW_BIT.b2

```

```

#define IMIEB TIERW_BIT.b1
#define IMIEA TIERW_BIT.b0
#define TSRW *(volatile unsigned char *)0xFF83
#define TSRW_BIT (*(struct BIT *)0xFF83)
#define IMFD TSRW_BIT.b3
#define IMFC TSRW_BIT.b2
#define IMFB TSRW_BIT.b1
#define IMFA TSRW_BIT.b0
#define TIOR0 *(volatile unsigned char *)0xFF84
#define TIOR0_BIT (*(struct BIT *)0xFF84)
#define IOB0 TIOR0_BIT.b4
#define TIOR1 *(volatile unsigned char *)0xFF85
#define TIOR1_BIT (*(struct BIT *)0xFF85)
#define IOD0 TIOR1_BIT.b4
#define IOC0 TIOR1_BIT.b0
#define TCNT *(volatile unsigned int *)0xFF86
#define GRA *(volatile unsigned int *)0xFF88

#define TCRV0 *(volatile unsigned char *)0xFFA0 /* Timer V */
#define TCSR0 *(volatile unsigned char *)0xFFA1
#define TCRV1 *(volatile unsigned char *)0xFFA2
#define TCSR1 *(volatile unsigned char *)0xFFA3
#define TCRV2 *(volatile unsigned char *)0xFFA4
#define TCSR2 *(volatile unsigned char *)0xFFA5
#define TCRV3 *(volatile unsigned char *)0xFFA6
#define TCSR3 *(volatile unsigned char *)0xFFA7
#define TCRV4 *(volatile unsigned char *)0xFFA8
#define TCSR4 *(volatile unsigned char *)0xFFA9
#define TCRV5 *(volatile unsigned char *)0xFFAA
#define TCSR5 *(volatile unsigned char *)0xFFAB
#define TCRV6 *(volatile unsigned char *)0xFFAC
#define TCSR6 *(volatile unsigned char *)0xFFAD
#define TCRV7 *(volatile unsigned char *)0xFFAE
#define TCSR7 *(volatile unsigned char *)0xFFAF
#define TCRV8 *(volatile unsigned char *)0xFFB0
#define TCSR8 *(volatile unsigned char *)0xFFB1
#define TCRV9 *(volatile unsigned char *)0xFFB2
#define TCSR9 *(volatile unsigned char *)0xFFB3
#define TCRV10 *(volatile unsigned char *)0xFFB4
#define TCSR10 *(volatile unsigned char *)0xFFB5
#define TCRV11 *(volatile unsigned char *)0xFFB6
#define TCSR11 *(volatile unsigned char *)0xFFB7
#define TCRV12 *(volatile unsigned char *)0xFFB8
#define TCSR12 *(volatile unsigned char *)0xFFB9
#define TCRV13 *(volatile unsigned char *)0xFFBA
#define TCSR13 *(volatile unsigned char *)0xFFBB
#define TCRV14 *(volatile unsigned char *)0xFFBC
#define TCSR14 *(volatile unsigned char *)0xFFBD
#define TCRV15 *(volatile unsigned char *)0xFFBE
#define TCSR15 *(volatile unsigned char *)0xFFBF

#define PUCR1 *(volatile unsigned char *)0xFFD0 /* I/O Port */
#define PUCR5 *(volatile unsigned char *)0xFFD1
#define PDR1 *(volatile unsigned char *)0xFFD4
#define PDR2 *(volatile unsigned char *)0xFFD5
#define PDR5 *(volatile unsigned char *)0xFFD8
#define PDR7 *(volatile unsigned char *)0xFFDA
#define PDR8 *(volatile unsigned char *)0xFFDB
#define PMR1 *(volatile unsigned char *)0xFFE0
#define PMR1_BIT (*(struct BIT *)0xFFE0)
#define IRQ0 PMR1_BIT.b4
#define PMR5 *(volatile unsigned char *)0xFFE1
#define PCR1 *(volatile unsigned char *)0xFFE4
#define PCR2 *(volatile unsigned char *)0xFFE5
#define PCR5 *(volatile unsigned char *)0xFFE8
#define PCR7 *(volatile unsigned char *)0xFFEA
#define PCR8 *(volatile unsigned char *)0xFFEB

```

```

#define      IEGR1      *(volatile unsigned char *)0xFFF2      /* IRQ0      */
#define      IENR1      *(volatile unsigned char *)0xFFF4
#define      IENR_BIT   (*(struct BIT *)0xFFF4
#define      IEN0       IENR_BIT.b0
#define      IRR1       *(volatile unsigned char *)0xFFF6
#define      IRR1_BIT   (*(struct BIT *)0xFFF6)
#define      IRR10      IRR1_BIT.b0
#define      MSTCR1     *(volatile unsigned char *)0xFFF9

#pragma interrupt (intpt_tmw)      /* Timer W interrupt      */
#pragma interrupt (r_stop)        /* IRQ0                    */
/* Function definition      */
extern void INIT (void);
void main(void);
void IO_INIT(void);
void intpt_tmw(void);
void r_stop(void);
void tmw_3(void);
void SA_1(void);
void SB_1(void);
void SC_1(void);

/* Data Table      */
const unsigned char data_0[6]=
{
    0x34,
    0x31,
    0x13,
    0x07,
    0x0d,
    0x1c
};

unsigned char x;      /* Counter for data table reference      */
unsigned char y;      /* Counter for timer function change      */
/* Vector Address      */
#pragma section V1
void (*const VEC_TBL1[])(void) = {
    INIT      /* H'0000 Reset vector      */

```

```
};
#pragma section V2 /* Timer W interrupt */
void (*const VEC_TBL2[])(void) = {
    intpt_tmw
};
#pragma section V3 /* IRQ0 interrupt */
void (*const VEC_TBL3[])(void) = {
    r_stop
};

#pragma section /* P */
/* main routine */

void main(void)
{
    set_imask_ccr(1); /* CCR -Ibit = 1 */
    IO_INIT(); /* initialize */
    TCNT=0x00;
    IMFA = 0;
    IMIEA = 1; /* enable IMIA */
    CTS = 1; /* Start Timer count */
    IRRIO= 0;
    IENO=1;
    set_imask_ccr(0); /* CCR -Ibit = 0 */
    while(1) {
        ;
    }
}

void IO_INIT(void)
{
    MSTCR1 = 0xf9;
    x=0; /* clear counter */
    y=0;

    PCR2 = 0x03;
    PDR2 = 0x03;
```

```

PMR5 = 0x00;
PUCR5 = 0x00;
PDR5 = 0x00;
PCR5 = 0xff;          /* Output Port5          */

PDR7 = 0x70;
PCR7 = 0x70;

PDR8 = 0xff;
PCR8 = 0xf1;

TCRV0 = 0x09;        /* Timer V initialize    */
TCRV1 = 0x02;        /* clock =  $\phi/4$         */
TCSRv = 0x16;
TCORA = 0xc8;        /* PWM period = 50 $\mu$ s    */
TCORB = 0x64;        /* PWM duty = 50%        */
TCNTV = 0x00;        /* TCNTV start           */

TMRW = 0x48;        /* Timer W initialize    */
TCRW = 0xb0;        /* Clock =  $\phi/8$         */
TIERW = 0x70;
TSRW = 0x70;
TIOR0 = 0xc8;
TIOR1 = 0xd8;
GRA = 0x4e20;        /* Port output period = 10.0ms */

IEGR1 = 0x70;
}
void r_stop(void)    /* IRQ0 interrupt routine */
{
    IRRIO = 0;
    TIERW = 0x70;
    PCR5 = 0x00;
}
while(1){
    ;
}
}
void intpt_tmw(void) /* Timer W interrupt routine */
{

```

```

if(IMFA==1){ /* Compare-match A ? */
    tmw_3();
}
if(IMFB==1){ /* FTIOB Input capture ? */
    SA_1();
}
if(IMFC==1){ /* FTIOC Input capture ? */
    SB_1();
}
if(IMFD==1){ /* FTIOD Input capture ? */
    SC_1();
}
}
void tmw_3(void) /* Compare-match A interrupt routine */
{

    IMFA =0;
    if(x < 6){
        PDR5 = data_0[x];
        x++;
        y++;
    }
    else{
        PDR5 = data_0[0]; /* If x > 6 = clear x */
        x=1;
        y++;
    }

    if(y > 0x06 && IMFB == 1 ){
        TIERW = 0x7e; /* disable IMIA */
    }
}

void SA_1(void) /* FTIOB input capture routine */
{
    IMFB = 0;
    if(IOB0 == 0){
        PDR5 = 0x1c;
        TIOR0 = 0xd8;
    }
}

```

```
        TIOR1 = 0xdc;
    }
    else{
        PDR5 = 0x13;
        TIOR0 = 0xc8;
        TIOR1 = 0xcd;
    }
}

void SB_1(void) /*FTIOC input capture routine */
{
    IMFC = 0;
    if(IOC0 == 0){
        PDR5 = 0x31;
        TIOR0 = 0xc8;
        TIOR1 = 0xcd;
    }
    else{
        PDR5 = 0x0d;
        TIOR0 = 0xc8;
        TIOR1 = 0xcc;
    }
}

void SC_1(void) /* FTIOD input capture routine */
{
    IMFD = 0;
    if(IOD0 == 0){
        PDR5 = 0x07;
        TIOR0 = 0xc8;
        TIOR1 = 0xdd;
    }
    else{
        PDR5 = 0x34;
        TIOR0 = 0xd8;
        TIOR1 = 0xcc;
    }
}
```

**Link Address Setting:**

<b>Section Name</b>	<b>Address</b>
CV1	H'0000
CV2	H'002A
CV3	H'001C
P	H'0100
B	H'FB80